

HSP

NOTES:

Current Rating:3.0AMP
 Withstand Voltage:500V AC/DC
 Contact Resistance:20mΩ Max
 Insulation Resistance:1000MΩMin
 Operation Temperature:--40°C to+105°C
 Contact Material:Phosphor Bronze
 Contact plating:Au or Sn over Ni
 Insulator Material:LCF+30%G.F.(UL94V-0)

Ordering Information

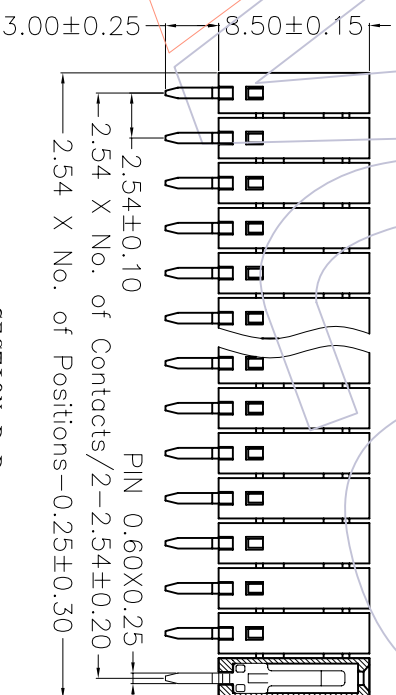
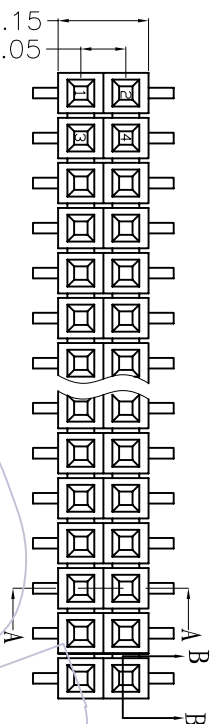
2185E - 2 XX W XX D UN TX

No. of Pins per Row:02~40Pin

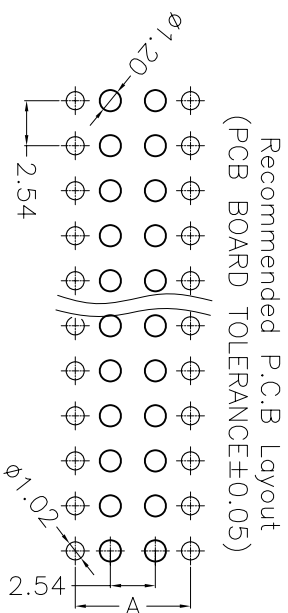
Contact Plating:
 G0=Gold Flash
 G1=3μr'Gold
 G2=5μr'Gold
 G3=10μr'Gold
 G4=15μr'Gold
 G5=30μr'Gold

S0=Gold Flash/Tin
 S1=3μr'Gold/Tin
 S2=5μr'Gold/Tin
 S3=10μr'Gold/Tin
 S4=15μr'Gold/Tin
 S5=30μr'Gold/Tin
 SN=Tin

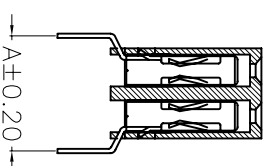
Packing:
 T=Tube
 Series No.
 1=6-50
 2=7-62
 3=5-70



SECTION: B-B



Recommended P.C.B Layout
 (PCB BOARD TOLERANCE±0.05)



SECTION: A-A

TITLE (DIM: A)	PART NO.
1=6.50	2185E-2XXXDUNT1
2=7.62	2185E-2XXXDUNT2
3=5.70	2185E-2XXXDUNT3

WCON 维峰五金电子有限公司
 WAVE HARDWARE ELECTRONICS CO. LTD

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	SEE TABLE
A1	08/06/11	Changing P.C.B Layout			XXX ±0.40	DESIGN	08.06.11	A4		
A0	08/03/12	NEW			XXX ±0.15	CHECK		1/1		
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	Angle DIM TOL	CHECK APPROVE		PROU.	TITLE: Customer NO.	

H A1 08/06/11 Changing P.C.B Layout

H A0 08/03/12 NEW

H REV DATE MODIFICATION DESCRIPTION CHANGE APPROVE

1 2 3 4 5 6 7 8 9 10